ABBOCIATION CONNECTING ELECTRONICS INDUSTRIES® Material Composition © Copyright 2005. IPC, Bar international and Pan-Amer	nockburn, Illinois. A	Il rights reserved u ntions.	under both	This docume level parts, t	ent is a declara he declaration	ation of the s	ubstances es all lowe	within the manufac r level materials for	turer listed which the	item. No manufac	ote: if the cturer has	item is an ass engineering i	sembly with lower esponsibility.	
	IPC Web Site for Information on IPC-1752 Standard Form Typ http://www.ipc.org/IPC-175x Distribute				Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Mater					als and Mfg Information				
Supplier Information														
Company name*	npany name* Company unique ID			Unique ID Authority					Response Date*					
ısemi					2024-0					4-05-07				
Contact Name	ntact Name Title - Contact]	Phone - Contact*				Email	Email - Contact*				
roduct-Env-Stewards Product Enviro Compliance					NA				Produ	Product-Env-Stewards@onsemi.com				
thorized Representative* Title - Representative]	Phone - Representative*				Email	Email - Representative*				
Product-Env-Stewards	Product Envi	oduct Enviro Compliance			NA				Produ	Product-Env-Stewards@onsemi.com				
Requester Item Number M	fr Item Number	Mfr Item Name			Effective Da	te Version	Ν	Manufacturing Site		Weight	t*	UOM	Unit Type	
FC	DM8801AR2	4SO HI-T TR T&	&R		2024-05-07		1	тнн		74.267		mg	Each	
Manufacturing Proccess Information					·								•	
Terminal Plating / Grid Array Material	Terminal Base	Ferminal Base Alloy		L Rating	Peak Pro	ak Process Body Temperature Max Time at		e Max Time at Pe	k Temperature Nur		Number of Reflow Cycles			
Precious metal (e.g. Ag,Au, NiPdAu) (Sn)	Precious metal (e.g. Ag,Au, NiPdAu) (no Sn)		1		245		C	30		seconds 3				
Comments	· · · · · · · · · · · · · · · · · · ·						·	·		<u>.</u>				
evel 1 - maximum time at peak temperature dur	ing soldering is 10-3	0 seconds												
or more information regarding material compo	sition please refer to	page 3												

RoHS Material Composition Declaration				Declaration Type *	Detailed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Disobutyl phthalate (DIBP).										
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe v others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and cc for issues that arise regarding inform	ce of its products with European Union membe	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of						
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	on above	Supplier Acceptance	* Accepted							
Exemption: If the declared item does not con applicable exemptions.	ntain RoHS restricted substances per	the definition above	except for defined RoHS exempti	ons, then select the corresponding response i	n the RoHS Declaration above and choose all						
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
Instructions: Complete all of the required fin Requester) and click on Submit Form to have	elds on all pages of this form. Select the form returned to the Requester	he "Accepted" on th	e Supplier Acceptance drop-down	. This will display the signature area. Digital	lly sign the declaration (if required by the						
Supplier Digital Signature Ra	stislav Drska	Le									

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	0.267	mg	В	Gallium Arsenide (AsGa)	1303-00-0		0.0864	mg
			Supplier	Silicon (Si)	7440-21-3		0.1754	mg
			Supplier	Aluminum (Al)	7429-90-5		0.0052	mg
Die Attach	0.25	mg	Supplier	Silver (Ag)	7440-22-4		0.205	mg
			Supplier	Dicyandiamine	461-58-5		0.0025	mg
			Supplier	Phenolic Resin (Novolac)	9003-35-4		0.0425	mg
Lead Frame	24.951	mg	Supplier	Silver (Ag)	7440-22-4		1.28	mg
			Supplier	Zinc (Zn)	7440-66-6		0.0449	mg
			Supplier	Iron (Fe)	7439-89-6		0.6138	mg
			Supplier	Copper (Cu)	7440-50-8		22.9774	mg
			Supplier	Phosphorus (P)	7723-14-0		0.0349	mg
Mold Compound-White	45.0	mg	Supplier	Titanium Dioxide (TiO2)	13463-67-7		11.25	mg
			В	Brominated Bisphenol A Diglycidyl Ether	40039-93-8		1.35	mg
			Supplier	Ortho Cresol Novolac Resin	29690-82-2		6.075	mg
			В	Antimony Trioxide (Sb2O3)	1309-64-4		1.35	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		22.5	mg
			Supplier	Phenolic Resin (Novolac)	9003-35-4		2.475	mg
Plating	0.239	mg	Supplier	Palladium (Pd)	7440-05-3		0.0095	mg
			В	Nickel (Ni)	7440-02-0		0.2238	mg
			Supplier	Gold (Au)	7440-57-5		0.0057	mg
Protective Coating	3.4	mg	Supplier	Poly(dimethylsiloxane), hydroxy terminated	70131-67-8		1.7	mg
			Supplier	Ethylbenzene	100-41-4		0.34	mg
			Supplier	Filler (SiO2)	68909-20-6		0.646	mg
			Supplier	Misc.	Proprietary Data		0.034	mg
			Supplier	Xylene	1330-20-7		0.68	mg
Wire Bond - Au	0.16	mg	Supplier	Gold (Au)	7440-57-5		0.16	mg